

To the Director, U.S. Patent and Trader

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original documents or copy thereof

Name of conveying party(ies): (List using letters or numbers for multiple parties)	2. Name and address of receiving party(ies):
Keun Soo Lee	Internal Address:
Additional name(s) of conveying party(ies) attached?	Name: Samsung SDI Co., Ltd. Internal Address: Street Address: 575 Shin-dong, Yeongtong-general Suwon-si
() Yes (X) No	City: Gyeonggi-do State: Korea ZIP:
3. Nature of conveyance: (X) Assignment () Security Agreement () Merger () Change of Name () Other:	Additional name(s) of receiving party(ies) attached? () Yes (X) No
Execution Date: (List as in section 1 if multiple	 US or PCT Application number(s) or US Patent number(s):
signatures) August 4, 2006	(X) Application(s) filed herewith Additional numbers attached?
	() Yes (X) No
Party to whom correspondence concerning document should be mailed:	Total number of applications and patents involved: 1
Customer No. 20,995	
Address: Knobbe, Martens, Olson & Bear, LLP 2040 Main Street, 14 th Floor Irvine, CA 92614 Return Fax: (949) 760-9502	
Attorney's Docket No.: SDISHN.023AUS	
7. Total fee (37 CFR 1.21(h)): \$40	8. Deposit account number: 11-1410
(X) Enclosed	Please charge this account for any additional fees which may be required, or credit any overpayment to this account.
Statement and signature.	
To the best of my knowledge and belief, the foregoing information is true and correct, and any attached copy is a true copy of the original document.	
John M. Carson	August 18, 2006
	ature Date
34,303 Registration No.	08/22/2006 HTECKLU1 00000039 11506698
Total number of pages including cover sheet, attachn% nf6:4001 document: 2 / 40.00 gp	
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PATENT REEL: 018215 FRAME: 0375

PATENT

Application No.: Filing Date:

Client Code: SDISHN. 023AUS Page 1

ASSIGNMENT

WHEREAS, I, the undersigned, have invented certain new and useful improvements in a ORGANIC LIGHT EMITTING DISPLAY AND METHOD OF MANUFACTURING THE SAME , the specification of which was executed on even date herewith.

AND WHEREAS, Samsung SDI Co., Ltd., (hereinafter "ASSIGNEE"), with its principal place of business at 575 Shin-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea, desires to acquire the entire right, title, and interest in and to the said improvements with respect to the United States of America, its territories and posessions.

NOW, THEREFORE, in light of good and valuable consideration, the receipt of which is hereby acknowledged. I, the said inventor, do hereby acknowledge that I have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title, and interest throughout the world in, to and under the said improvements, and the said application and all provisional applications relating thereto, and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all rights of priority under International Conventions and applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and I hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvements to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I HEREBY covenant and agree that we will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful onths and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

August 4, 2006 Date:

KEUN SOO LEE

Name: Keun Soo Lee

Address: Top-maeul Jugong 8 Apt. 805-309, Yatap-

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